EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	0	(29/610.1,613,620,825).ccls. and tray and (antistatic same polymer same conductive) and cut\$4 and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 23:29
L7	4	(29/610.1,613,620,825).ccls. and tray and (polymer and conductive) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 23:31
L8	3	(206/719).ccls. and tray and (polymer and conductive) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 23:32
L9	10	(257/629,660,678,687).ccls. and tray and (polymer and conductive) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 23:32
L10	32	(428/141,323).ccls. and tray and (polymer and conductive) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 23:33
L11	1	(428/141,323).ccls. and tray and (antistatic same polymer same conductive) and cut\$4 and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 23:34
S1	23	(suh-kwang-suck).in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 12:02
\$2	3	(suh-kwang-suck).in. and (ground adj resistance)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 12:02

S 3	3	(kim-jong-eun).in. and (ground adj resistance)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 12:52
S5	72	tray and (antistatic with polymer with conductive) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 13:11
S6	4	("3981074" "5428100" "5599621" "6896828").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/06/03 13:14
S7	57	tray and (antistatic same polymer same conductive) and cut\$4 and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 13:35
S 8	57	tray and (antistatic same polymer same conductive) and (cut or cutting) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 13:36
S9	3	("20020060314" "5643990" "5651922").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/06/03 13:43
S10	3	("20020060314" "5643990" "5651922"). <i>P</i> N.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/06/03 13:53
S11	3	("20020060314" "5643990" "5651922"). <i>P</i> N.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/06/03 13:57
S12	1	("6780490").URPN.	USPAT	OR	OFF	2008/06/03 13:57
S13	48	tray and (antistatic same polymer same conductive) and (open or opening) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 14:02
S14	6	("3676118").URPN.	USPAT	OR	OFF	2008/06/03 14:03
S16	472	tray and (conductive) with (cut or cutting) and (electronic or chip or component or semiconductor)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/03 14:06
S18	9	(ionic adj surfactant) same tray	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 21:34

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